

F

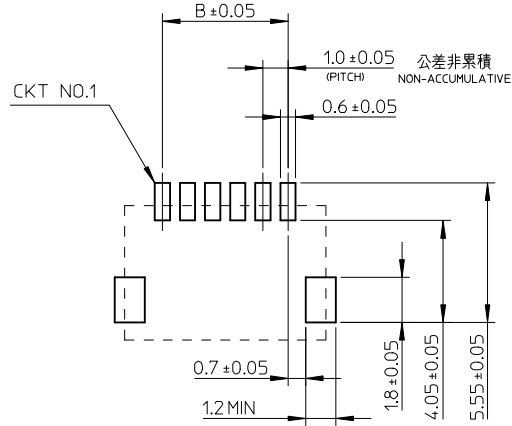
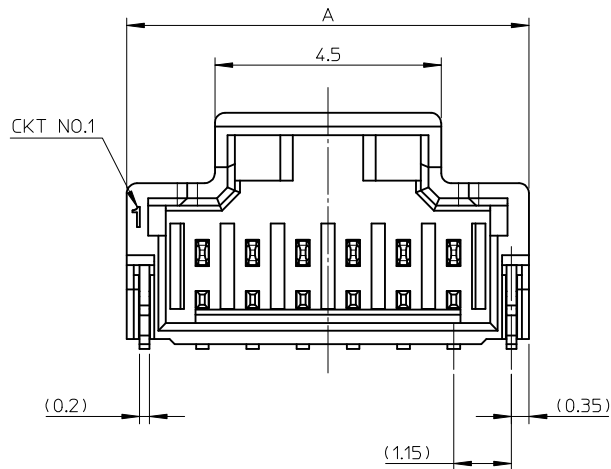
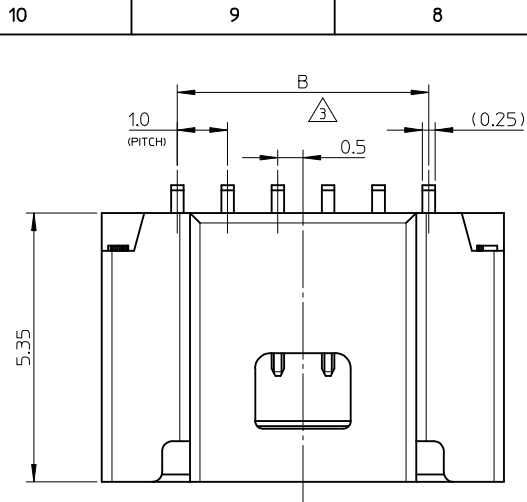
E

D

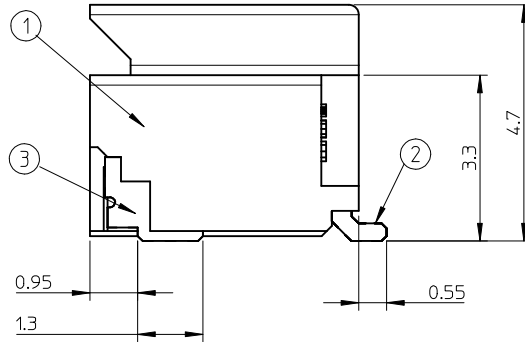
C

B

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参考パターンレイアウト
RECOMMENDED PATTERN DIM.(REF)
SCALE:5-1



番号 NO.	部品 PART	材質 MATERIAL
①	ウェハー WAFER	耐熱ナイロン、UL94V-0 HEAT RESISTANCE NYLON, UL94V-0
②	ソルダーピン SOLDER PIN	りん青銅 PHOSPHOR BRONZE すずメッキ : 1 MICRO METER MINIMUM. TIN PLATING ニッケル下地メッキ : 1 MICRO METER MINIMUM. NICKEL UNDER PLATING
③	ネイル NAIL	黄銅 BRASS すずメッキ : 1 MICRO METER MINIMUM. TIN PLATING ニッケル下地メッキ : 1 MICRO METER MINIMUM. NICKEL UNDER PLATING

14.0	17.0	15
13.0	16.0	14
12.0	15.0	13
11.0	14.0	12
10.0	13.0	11
9.0	12.0	10
8.0	11.0	9
7.0	10.0	8
6.0	9.0	7
5.0	8.0	6
B	A	極数 CIRCUITS

NOTES

- かん相手 : 501330-****
MATE WITH : 501330-****
- ソルダーピン及びネイルの平坦度は0.1MAX.
SOLDER PIN AND NAIL COPLANARITY TO BE 0.1MAX.
- 極数 = 偶数に適用
APPLY FOR CKT SIZE=EVEN
- 2~5極は、SD-501568-001を参照下さい。
REFER TO SD-501568-001 ABOUT 2-5CKT.
- ELV AND RoHS COMPLIANT.

CONNECTOR SERIES No. 501568-***9

REVISED EC NO: J2010-0339 DRWN: INAKAGAWA01 2009/09/01 CHKD: MATSUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY AMIZUMURA	DATE 2005/01/19	TITLE 1.0 WIRE TO BOARD CONN. 1-ROW R/A WAFER ASSY 6-15CKT			
		10 OVER 30 UNDER	± 0.25	CHECKED BY MYAGI	DATE 2005/01/19				
		30 OVER	± 0.3	APPROVED BY ANODA	DATE 2005/01/19	MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO.					DOCUMENT NO.
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 2		SD-501568-002		1 OF 2		
REV		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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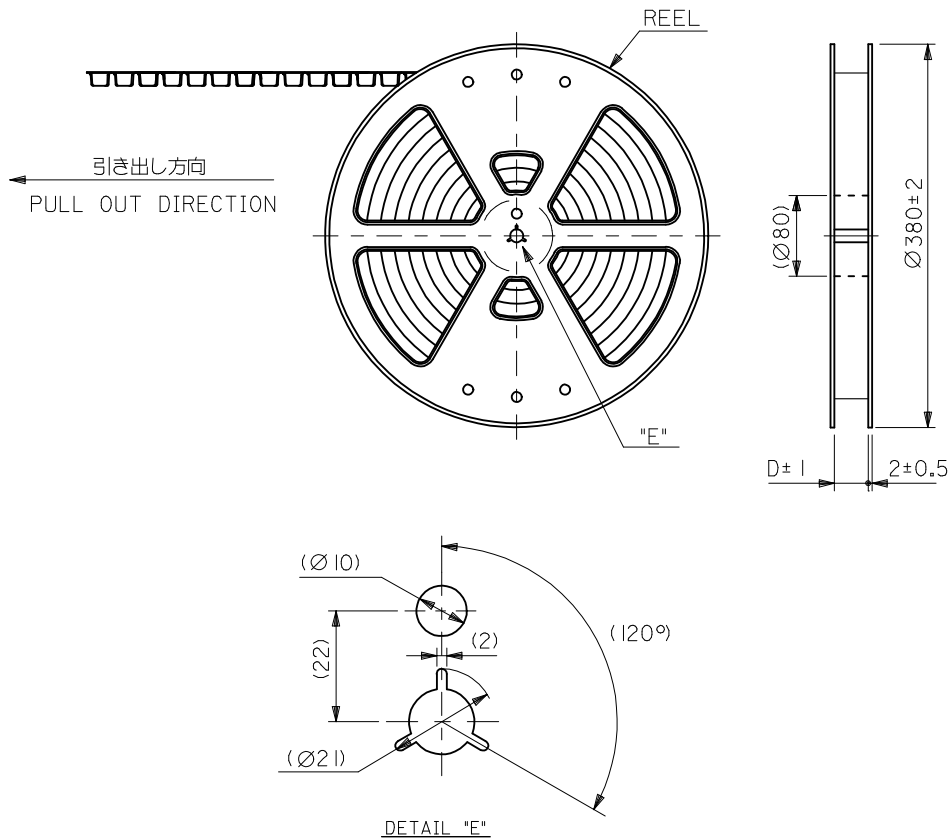
E

D

C

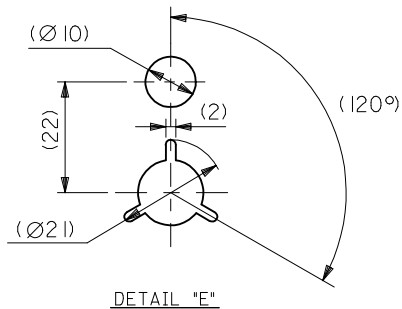
B

A



NOTES

- 製品詳細寸法は製品単体図面を参照して下さい。
FOR DETAIL OF CONNECTOR DIMENSIONS, PLEASE SEE THE DRAWING OF CONNECTOR ITSELF (NOT PACKAGED).
- 梱包数量: 1300 個/リール
NUMBER OF CONNECTORS: 1300 PIECES/REEL
- リードテープ長さ
LEAD TAPE LENGTH
トップテープ接着部(空エンボス)
20 PIECES. MIN.
TOP TAPE BONDED PART (EMPTY)
部品挿入部
COMPONENT SUPPLIER
末端部(空部)
TAIL PART (EMPTY)
160 MIN.
400 MIN.
- 材料
MATERIAL
キャリアテープ: ポリプロピレン
CARRIER TAPE: POLYPROPYLENE
トップテープ: PET, PE, REF
TOP TAPE
リール: ポリスチレン <リサイクル材を含む>
REEL: POLYSTYRENE <RECYCLE MATERIAL CONTAINED>
- ELV AND RoHS COMPLIANT.
- ハイバリア梱包(シリカゲル入り)対応品である。(501568-**-07除く)
THIS PRODUCT IS HIGH BARRIER PACKAGE (WITH SILICAGEL)
(BESIDES 501568-**-07)
- 開梱後の保管条件に注意のこと。(ハイバリア品対象: PS-501568-001参照)
REFER TO PS-501568-001 (HIGH BARRIER PRODUCT)
FOR CONDITIONS AFTER OPEN.

引き出し方向
PULL OUT DIRECTION

DETAIL "E"

REVISED EC NO: J2010-0339 DRWN: TNAKAGAWA01 2009/09/01 CHKD: MATSUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY AMIZUMURA	DATE 2005/1/26	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW R/A) EMBTP PKG				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MYAGI	DATE 2005/1/26					
		30 OVER	± 0.3	APPROVED BY ANODA	DATE 2005/1/26	MOLEX INCORPORATED				
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 3		SD-501568-006		1 OF 3		
	REV		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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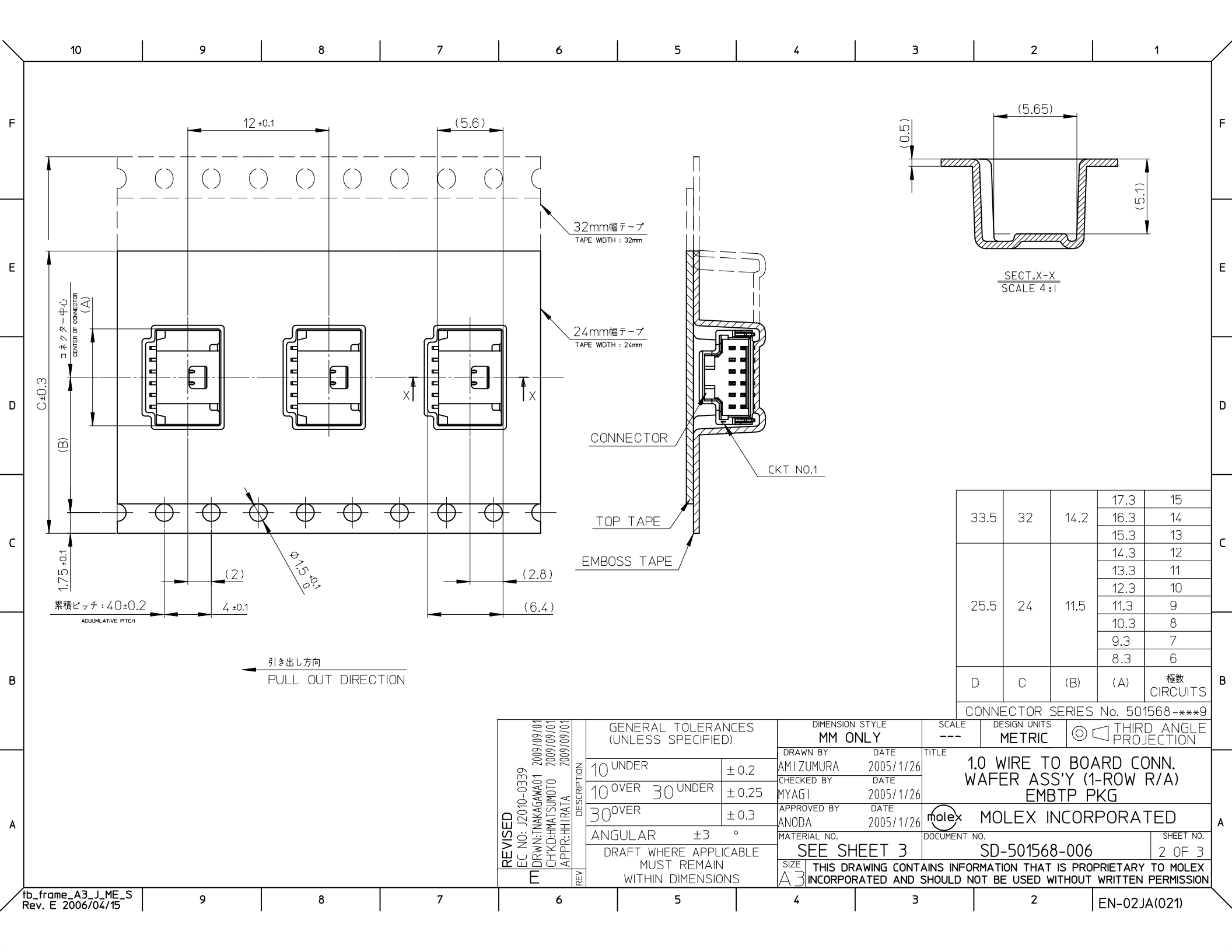
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33.5	32	14.2	17.3	15
			16.3	14
			15.3	13
			14.3	12
			13.3	11
			12.3	10
25.5	24	11.5	11.3	9
			10.3	8
			9.3	7
			8.3	6
D	C	(B)	(A)	極数 CIRCUITS

CONNECTOR SERIES No. 501568-***9

REVISED EC NO: J2010-0339 DRWN: TNAKAGAWA01 2009/09/01 CHKD: MATSUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION					
		10 UNDER	±0.2	DRAWN BY AMIZUMURA	DATE 2005/1/26	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW R/A) EMBTP PKG							
		10 OVER 30 UNDER	±0.25	CHECKED BY MYAGI	DATE 2005/1/26								
		30 OVER	±0.3	APPROVED BY ANODA	DATE 2005/1/26	MOLEX INCORPORATED							
		ANGULAR ±3 °		MATERIAL NO.							DOCUMENT NO.		SHEET NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 3							SD-501568-006		2 OF 3
	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

	10	9	8	7	6	5	4	3	2	1	
F											F
E											E
D											D
C											C
B											B
A											A

紫 VIOLET	501568-1597		501568-1587		501568-1577		501568-1567		15	
	501568-1497		501568-1487		501568-1477		501568-1467		14	
	501568-1397		501568-1387		501568-1377		501568-1367		13	
	501568-1297		501568-1287		501568-1277		501568-1267		12	
	501568-1197		501568-1187		501568-1177		501568-1167		11	
	501568-1097		501568-1087		501568-1077		501568-1067		10	
	501568-0997		501568-0987		501568-0977		501568-0967		9	
	501568-0897		501568-0887		501568-0877		501568-0867		8	
	501568-0797		501568-0787		501568-0777		501568-0767		7	
	501568-0697		501568-0687		501568-0677		501568-0667		6	
EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		極数		
オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		CIRCUTIS		
CONNECTOR SERIES No. 501568-***9										
青 BLUE	501568-1547		501568-1537		501568-1527		501568-1507		15	
	501568-1447		501568-1437		501568-1427		501568-1407		14	
	501568-1347		501568-1337		501568-1327		501568-1307		13	
	501568-1247		501568-1237		501568-1227		501568-1207		12	
	501568-1147		501568-1137		501568-1127		501568-1107		11	
	501568-1047		501568-1037		501568-1027		501568-1007		10	
	501568-0947		501568-0937		501568-0927		501568-0907		9	
	501568-0847		501568-0837		501568-0827		501568-0807		8	
	501568-0747		501568-0737		501568-0727		501568-0707		7	
	501568-0647		501568-0637		501568-0627		501568-0607		6	
EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		EMBOSSSED PACKAGE		極数		
オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		オーダー番号 ORDER NO.		CIRCUTIS		
CONNECTOR SERIES No. 501568-***9										
REVISED	EC NO: J2010-0339 DRAWN: TAKAGAWA01 2009/09/04 CHKD: HMATSUMOTO 2009/09/04 APPR: HIRATA 2009/09/04	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
			10 UNDER ±---		DRAWN BY DATE AMIZUMURA 2005/1/26		TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW R/A) EMBTB PKG			
			10 OVER 30 UNDER ±---		CHECKED BY DATE MYAGI 2005/1/26					
			30 OVER ±---		APPROVED BY DATE ANODA 2005/1/26		MOLEX INCORPORATED			
			ANGULAR ±--- °		MATERIAL NO.					
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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